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### PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4887803

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SOONHYUN PARK	03/31/2017
DONGSOON KIM	03/31/2017
SUNMIN LEE	03/31/2017

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City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	35503789

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ATTORNEY DOCKET NUMBER:	0465-6493PUS1
NAME OF SUBMITTER:	PHILLIP R. TASHJIAN
SIGNATURE:	/Phillip R. Tashjian/
DATE SIGNED:	03/28/2018

**Total Attachments: 2** 

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**PATENT** REEL: 045374 FRAME: 0007 504841066

# BIRCH, STEWART, KOLASCH & BIRCH, LLP

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## **ASSIGNMENT**

Application	35/503,789	Filed:	March 31, 2017			
No.:						
Insert Name(s	***(Given Name FAMILY I DWHEREAS,					
ot Inventor(s)	(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:					
Insert Title of Invention	WIRELESS HEADSE	et[comm	UNICATION DEVICE]			
	for which an application	on for Lette he case of a p	rs Patent of the United States of America has been executed by the provisional application)			
Insert Date of Signing of Appln.	on	······	; and			
Insert Name of Assignee	WHEREAS, LG Electron	ics Inc.				
Insert Address of Assignee	of 128, Yeoui-daero, Yeo	ngdeungpo-	gu, Seoul, 07336, Republic of Korea,			
	its heirs, successors, leg acquiring the entire righ be granted therefor in th	t, title and ir	atives and assigns (hereinafter designated as the Assignee) is desirous of tterest in and to said invention and in and to any Letters Patent(s) that may tes of America and			
Check Box if Appropriate	in any foreign cour	itries.				
	undersigned has (have) unto said Assignee the territories, dependencie Patent(s) which may be possessions, and if the b	sold, assigned full and extending some set of the solution of the solution of the solution is solution and solution and solution is solution and solution is solution and solution is solution and solution and solution is solution and solution is solution and solution is solution and solution	valuable consideration, the receipt of which is hereby acknowledged, the ad and transferred, and by these presents does (do) sell, assign and transfer aclusive right to the said invention in the United States of America, its sions and the entire right, title and interest in and to any and all Letters erefor in the United States of America, its territories, dependencies and designated, in any and all foreign countries; and to any and all divisions, and extensions thereof for the full term or terms for which the same may			

BSKB-ASSIGN-SINGLE (09-12) JTE/cdr

<OrgName>

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of (a) valid United States of America patent(s) or a grant of (a) valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment. In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s)

Date_March 31, 2017	Name of Inventor	(Signature) Soonhyun PARK	
Date March 31, 2017	Name of Inventor	(Signature) Dongsoon KIM	
Date March 31, 2017	Name of Inventor	(Signature) SUNMIN LEE	
Date	Name of Inventor	(Signature)	
Date	Name of Inventor	(Signature)	
<orgname></orgname>		Page 2	BSKB-ASSIGN-SINGLE (09-12) <rsp>/<wrk>/<usr></usr></wrk></rsp>

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